505611824 08/08/2019

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HAILONG WANG	07/26/2019

RECEIVING PARTY DATA

Name:	AAC TECHNOLOGIES PTE. LTD.	
Street Address:	85 SCIENCE PARK DRIVE #02-08, THE CAVENDISH, SINGAPORE 118259	
City:	SINGAPORE CITY	
State/Country:	SINGAPORE	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16530982

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: mail@uni-intel.com

Correspondent Name: MICHAEL WIERSCH

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ATTORNEY DOCKET NUMBER:	2019A0722US	
NAME OF SUBMITTER:	R: MICHAEL P. WIERSCH	
SIGNATURE:	/Michael P. Wiersch #55996/	
DATE SIGNED: 08/08/2019		
	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 2

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PATENT 505611824 REEL: 049995 FRAME: 0889

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ASSIGNMENT		
WHEREAS I/We, the below named inventor(s) (hereinafter referred to as Assignor(s)) have made an invention entitled:		
LENS MODULE		
for which I/We executed an application for United States Letters Patent concurrently herewith or filed an application for United States Letters Patent on(Application No); and		
WHEREAS, AAC Technologies Pte. Ltd., a corporation of Singapore whose post office address is 85 Science Park Drive #02-08. The Cavendish. Singapore 118259 (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;		
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/We, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention, provisional Application No.		
filed		
AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;		
AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.		
AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No		

PATENT

Attorney Docket No.: 2019A0722US

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Inventor:

Name:

Address:

Hailong Wang
A-Block, Nanjing University Research Center
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P.R.China

Signature:

Date:

2

PATENT REEL: 049995 FRAME: 0891

RECORDED: 08/08/2019